



Ruggedized Packaging of High-Power Quantum Cascade Lasers

The background features a grayscale image of a sharp mountain peak, likely the Matterhorn, with snow patches. Overlaid on this are several horizontal red lines that curve and wobble, resembling laser beams or signal paths.

Arunkrishnan Radhakrishnan, PhD
Laser Scientist, Alpes Lasers

Pioneering **photonics** for a brighter future 

Outline

1. Company Outline
2. Applications (High power QCLs)
3. Ruggedized Packaging
4. Hermetic Sealing
5. Qualification Tests
6. Conclusion

Alpes Lasers



Products

Laser Modules



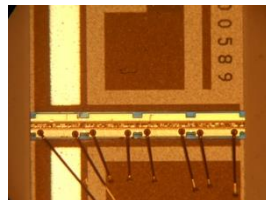
Laser Package



TO-3



Laser Driver



Chip on submount

Laser Systems

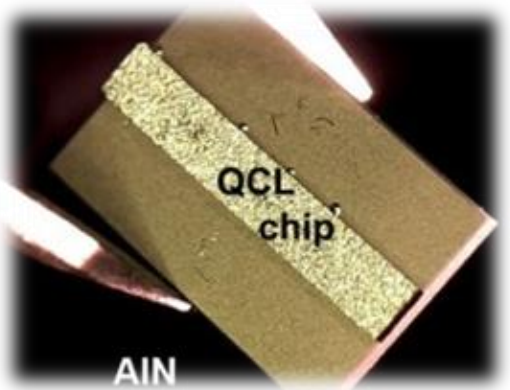


Glider

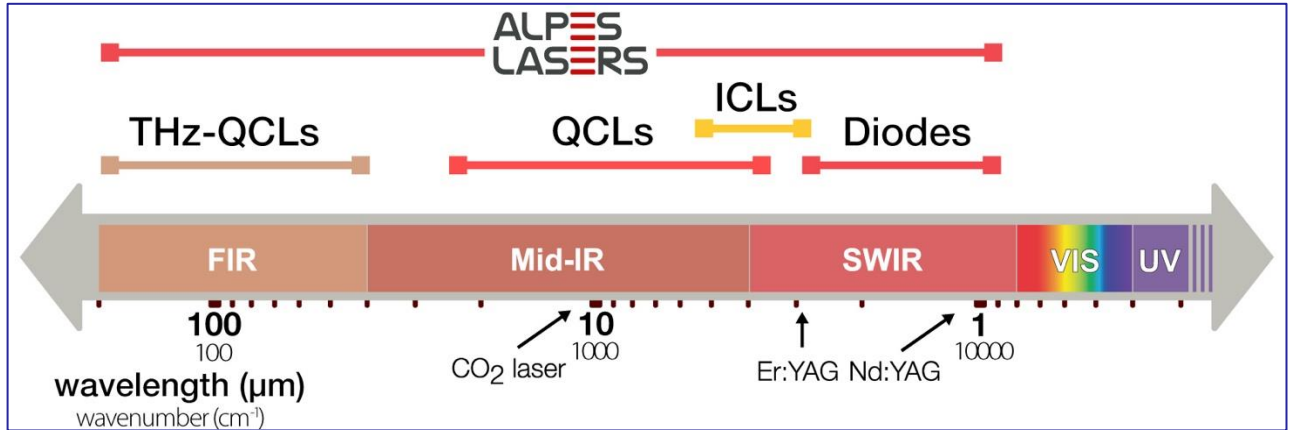


Pointer

- Headquarter in St. Blaise, Switzerland
- Work force : 40 people
- Worldwide operation
- Founded by Prof. Jerome Faist and Dr. Antoine Muller.



Quantum Cascade Laser



Applications

- > Instruments calibration
- > Defense and security

- > Laser-based communication
- > Spectroscopic instrumentation



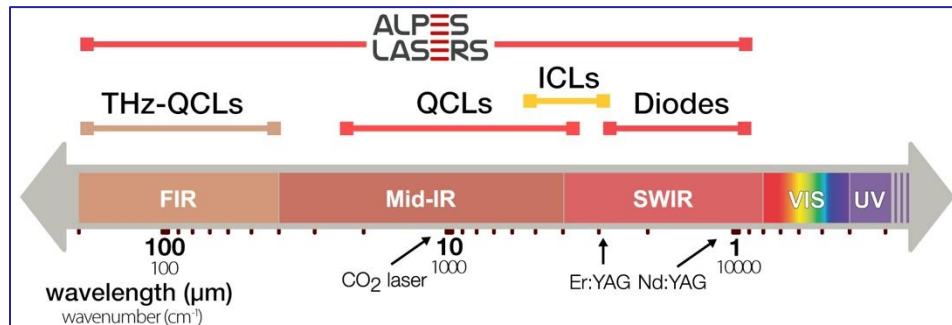
- > Greenhouse gases measurement
- > Water and ground pollution monitoring
- > Air quality monitoring
- > Micro plastic monitoring

- > Health: Blood and liquids analysis
- > Medical: VOC analysis in breath
- > Medical hyperspectral imaging
- > Biology: Biomarkers monitoring

- > Oil & gas leak detection
- > Process monitoring
- > Hazardous substances detection
- > Food safety

Applications

- > Instruments calibration
- > **Defense and security**
- > Laser-based communication
- > Spectroscopic instrumentation



Mid wave IR (3-5 microns)

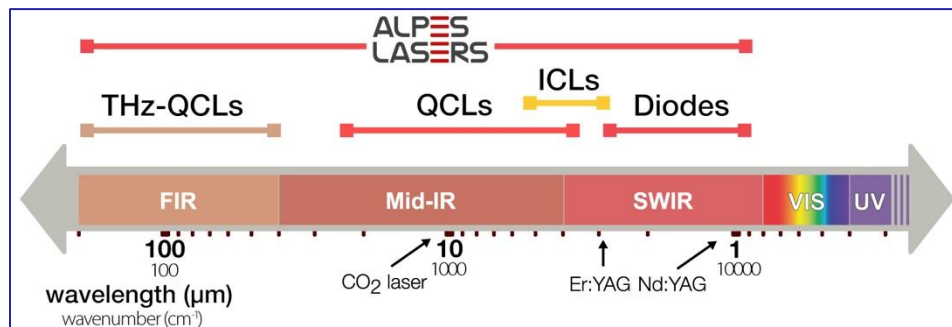
Directional counter-measure applications

- High-Power laser >1W at MWIR regime
- Ruggedized packaging design
- Wavelength specific



Applications

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Mid wave IR (3-5 microns)

Directional counter-measure applications

- High-Power laser >1W at MWIR regime
- Ruggedized packaging design
- Wavelength specific



Ruggedized Packaging

Specifications

Beam pointing tolerance:

Horizontal/Vertical: ± 3 mRad

Beam pointing retention:

Horizontal: ± 0.7 mRad, Vertical: ± 0.4 mRad

Beam divergence tolerance:

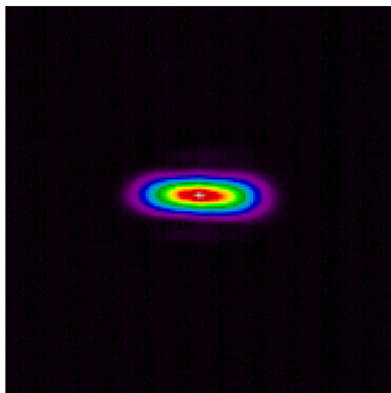
Horizontal: ± 1.0 mRad, Vertical: ± 0.5 mRad

Beam divergence retention: $\pm 10\%$ of divergence



During and after any combination of the following environmental conditions:

1. **Ambient temperature* (operating):** -54°C to $+71^{\circ}\text{C}$
2. Storage temperature (non-operating): -54°C to $+71^{\circ}\text{C}$
3. **Thermal shock:** $+55^{\circ}\text{C}$ to 0°C , rate = 11°C
4. Vibrations: $0.04 \text{ g}^2/\text{Hz}$, from 20 Hz to 2 kHz, 1 hour per axis
5. **Mechanical shocks:** 85 g, 5 ms, half-sine profile, 6 shocks per axis

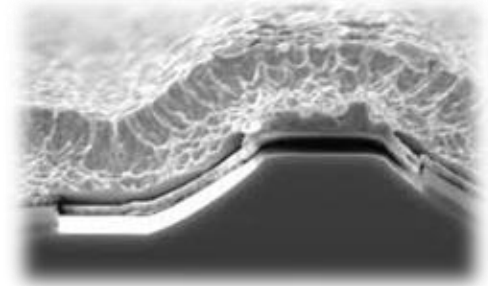
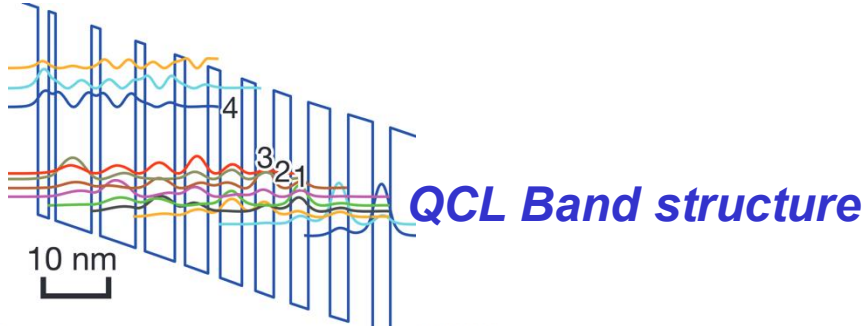


Beam profile

Steps in Packaging

Design and Simulation

1. Chip design

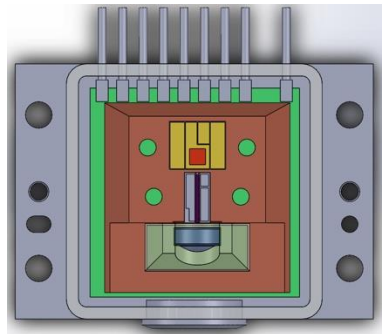


2. Optical design

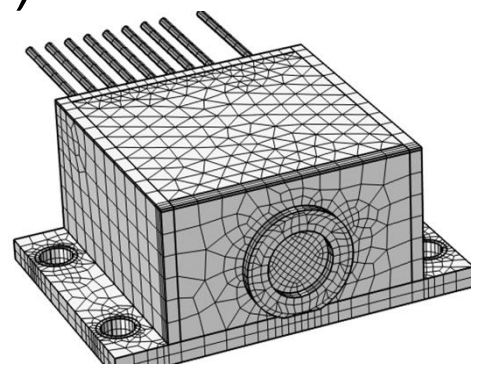


3. Mechanical design and simulation

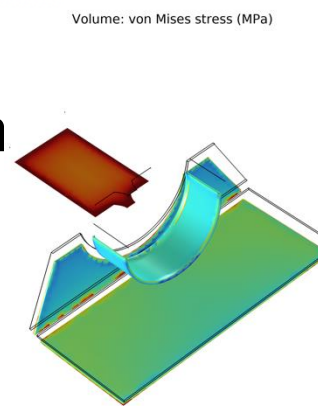
(CAD and FEA)



CAD Design

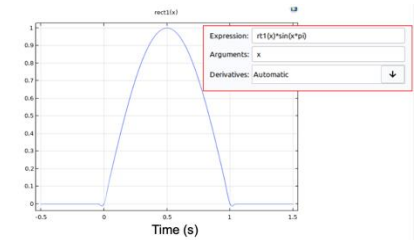
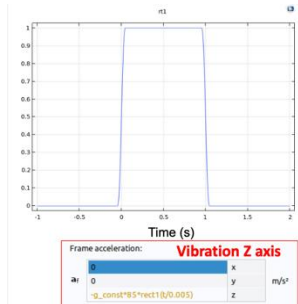


Simulation Model



- Linear Elastic laws
- Viscoplastic law
- Viscoelastic law
- Creep and fatigue analysis
- Modal, harmonic and dynamic analysis

Thermal stress analysis (-40°C, Operational state)



Shock vibration analysis

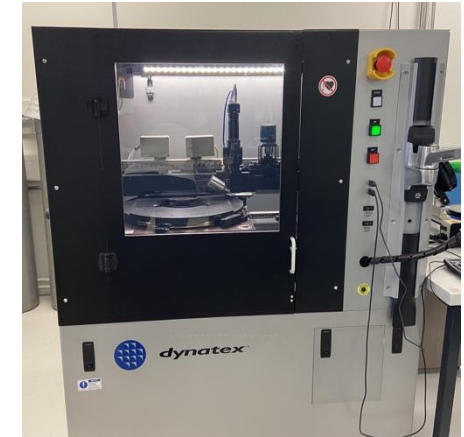
Fabrication of laser module

1. Cleaving

- *Automated scribe and break*



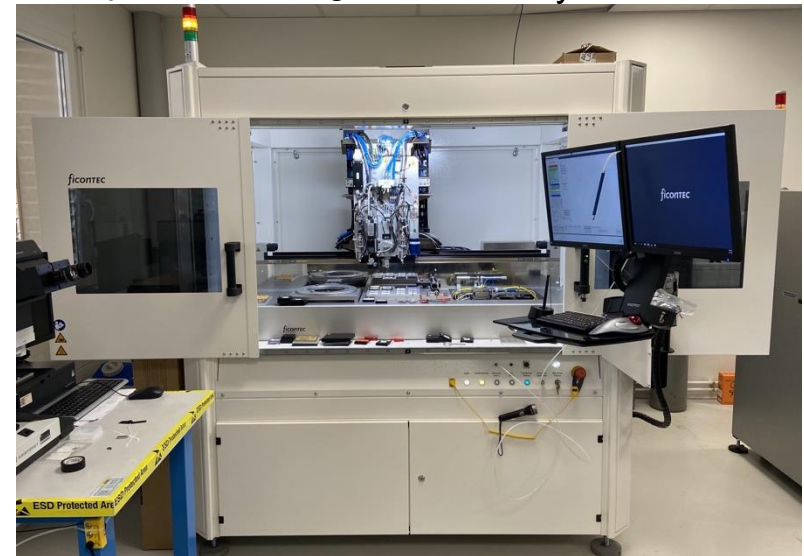
Chips for cleaving



Dynatex cleaver

2. Automated Die Bonder

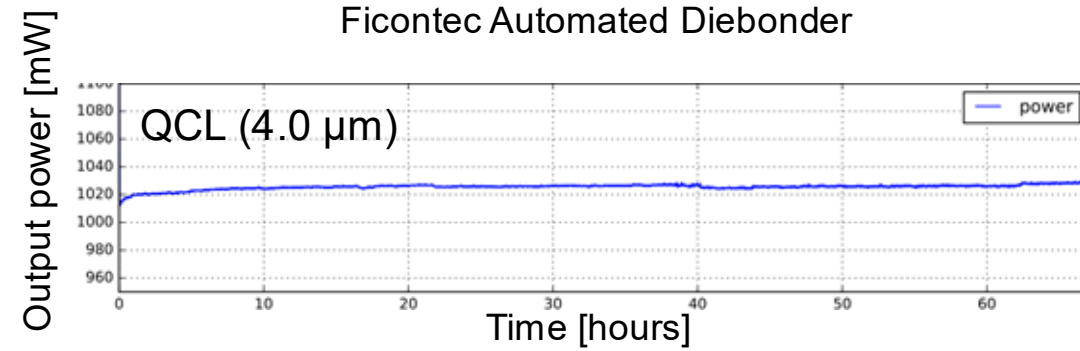
- *Soldering chip on submount
(Epi up and Epi down)*
- *Soldering sub-mount to insert*
- *Improved precision (± 2 microns)
and high throughput.*



Ficontec Automated Diebonder

3. Burn-in

- *Burned in for at-least 200 hours.*
- *Life time estimate using ALT.*



Steps in Packaging

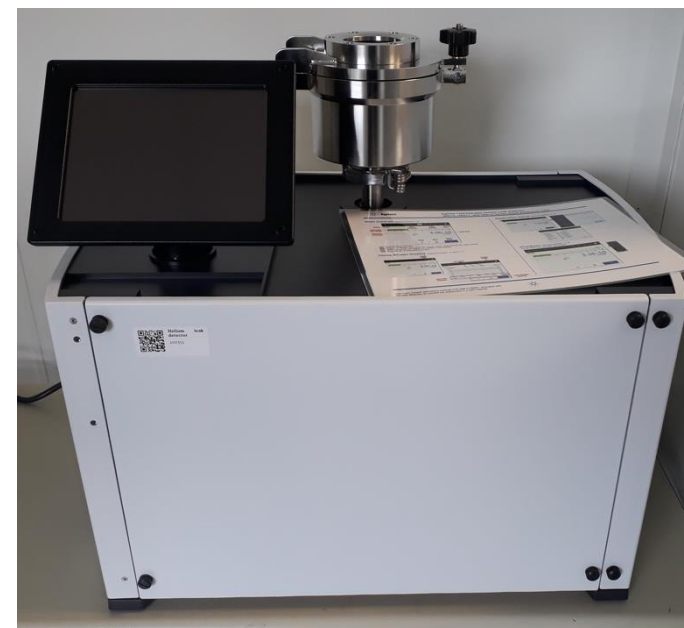
4. Optical assembly (hot alignment)

- In-house Optical assembly with pyro electric camera.
- Automated optical assembly in future.

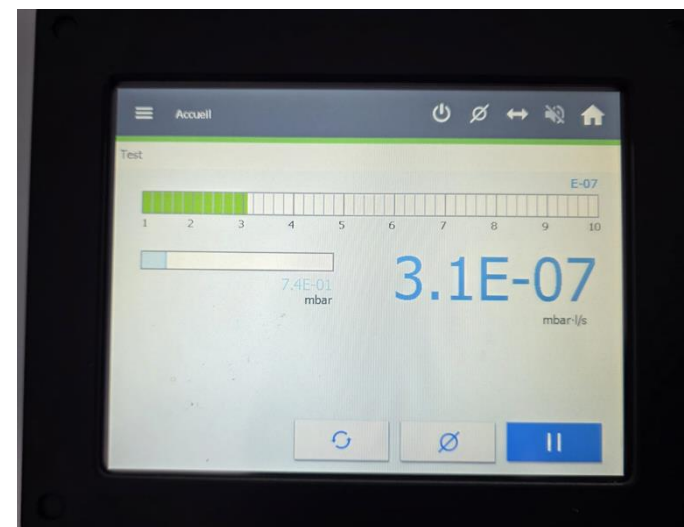
5. Hermetic sealing and leak detection



Labstar Eco seam sealer



Leak detector



We have the capability to have produce hermetic sealing with leak rate $< 1 \times 10^{-6}$ mbar l/s (MIL-STD-883H) with He.

Qualification tests

Thermal tests

- Both operational and storage temperature tests.
- Temperature range: -80 to 120°C.
- **Low and high temperature cycles** (MIL-STD 810F)

Shock/Vibration tests

- Shock: 85g for 5 ms
- Can recreate various vibration profiles (flights, helicopters etc)



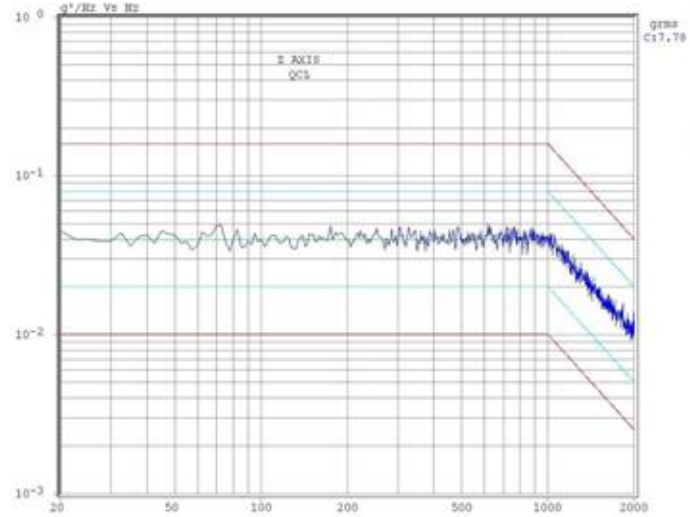
Operational thermal tests



Vibration shaker machine



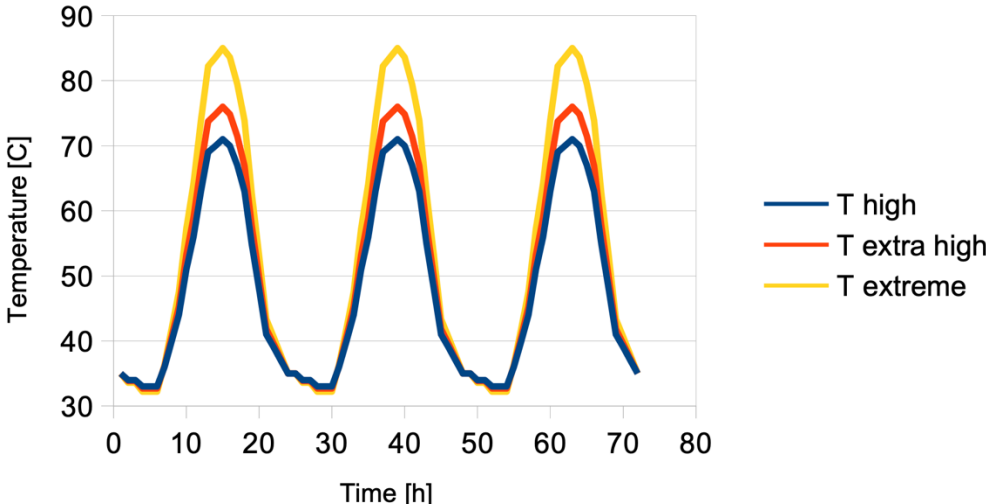
Vibration profile 0.04g²/Hz (MIL-STD 810F)



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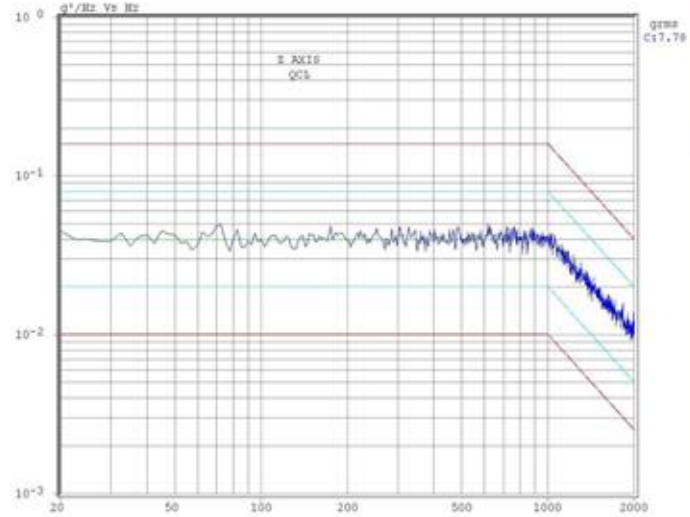
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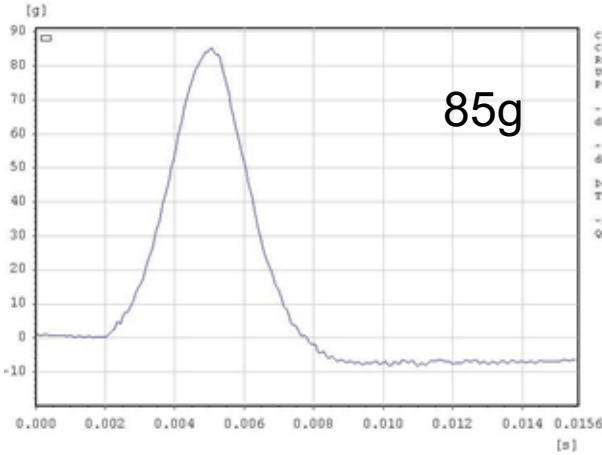
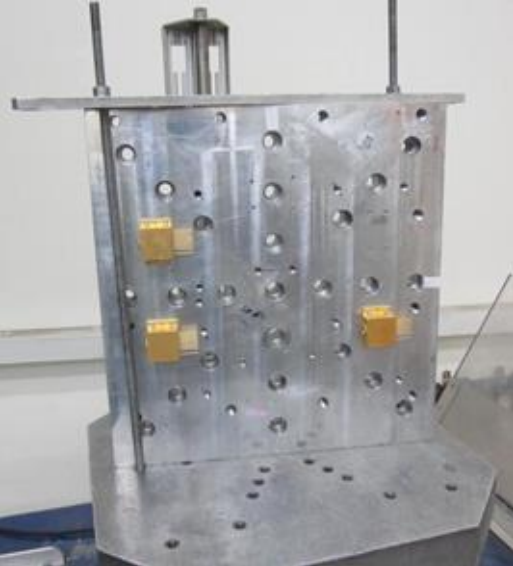
Vibration shaker machine



Vibration profile 0.04g²/Hz (MIL-STD 810F)

Qualification tests

Mechanical Shock Tests



10-15g



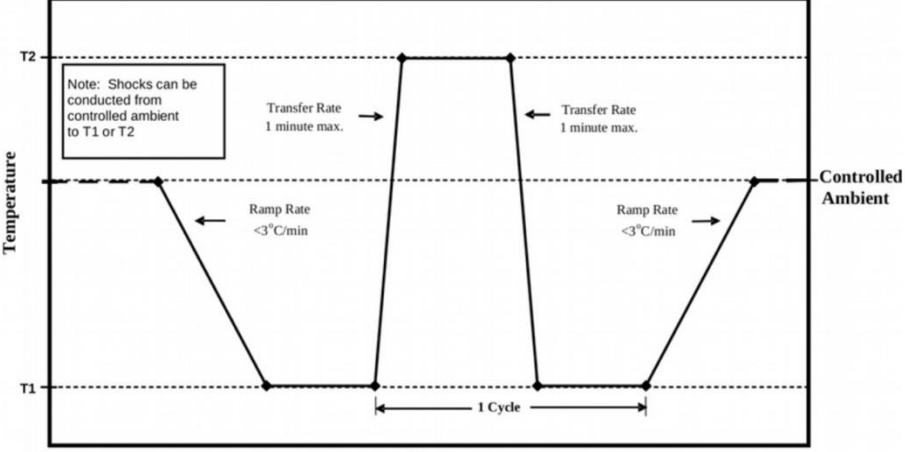
60-80g

- > As per MIL-STD 810F, Method 516.5, procedure I
- > Half sine, 85 g, 5 ms
- > 3 axes, 6 shocks per axis

Thermal Shock Tests

- > Profile based on MIL-STD 810G

We perform rigorous line of sight (LOS) and beam divergence measurements after each qualification tests.



Thermal shock profile

What we offer

- Customised chip design (QCLs, ICLs etc).
- Ruggedized packaging solutions.
- **Hermetic sealing and leak detection** of laser modules.
- Cryogenic and cyclic thermal tests.
- Vibration and shock measurements.
- Laser characterization.
- Customised laser systems based on customer requirements.
- Collaborative R&D projects (10+ ongoing).



ALPES LASERS

Thank you for your attention

www.alpeslasers.ch

